# **5.0 V ECL 2:1 Multiplexer**

### Description

The MC10EL/100EL58 is a 2:1 multiplexer. The device is functionally equivalent to the E158 device with higher performance capabilities. With propagation delays and output transition times significantly faster than the E158, the EL58 is ideally suited for those applications which require the ultimate in AC performance.

The 100 Series contains temperature compensation.

#### **Features**

- 230 ps Propagation Delay
- PECL Mode Operating Range:  $V_{CC} = 4.2 \text{ V}$  to 5.7 V with  $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range:  $V_{CC} = 0 \text{ V}$  with  $V_{EE} = -4.2 \text{ V}$  to -5.7 V
- Internal Input Pulldown Resistors on Da, Db, and SEL
- Pb-Free Packages are Available

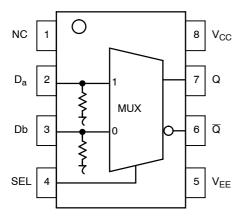


Figure 1. Logic Diagram and Pin Assignment



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#### MARKING DIAGRAMS\*



SOIC-8 D SUFFIX CASE 751







TSSOP-8 DT SUFFIX CASE 948R











#### DFN8 MN SUFFIX CASE 506AA

1

 $\begin{array}{lll} H &= MC10 & L &= Wafer\ Lot \\ K &= MC100 & Y &= Year \\ 4Z &= MC10 & W &= Work\ Week \\ 2O &= MC100 & \overline{M} &= Date\ Code \\ A &= Assembly\ Location & \bullet &= Pb-Free\ Package \\ \end{array}$ 

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

**Table 1. PIN DESCRIPTION** 

PIN	FUNCTION
D <sub>a</sub> , Db Q, Q SEL V <sub>CC</sub> V <sub>EE</sub> NC EP	ECL Data Inputs ECL Data Outputs ECL Select Input Positive Supply Negative Supply No Connect Exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply or leave floating open.

**Table 2. FUNCTION TABLE** 

SEL*	Data
H	a
L	b

<sup>\*</sup> Pin will default low when left open.

**Table 3. ATTRIBUTES** 

Character	istics	Value				
Internal Input Pulldown Resistor	Internal Input Pulldown Resistor					
Internal Input Pullup Resistor	N/A					
ESD Protection	Human Body Model Machine Model	> 1 kV > 100 V				
Moisture Sensitivity, Indefinite Time	Out of Drypack (Note 1)	Level 1				
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in				
Transistor Count		45				
Meets or exceeds JEDEC Spec El/	A/JESD78 IC Latchup Test					

<sup>1.</sup> Refer to Application Note AND8003/D for additional information.

**Table 4. MAXIMUM RATINGS** 

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		8	V
V <sub>EE</sub>	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-8	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	$\begin{array}{c} V_I \leq V_{CC} \\ V_I \geq V_{EE} \end{array}$	6 -6	V V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-8 SOIC-8	190 130	°C/W °C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction-to-Case)		SOIC-8	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	TSSOP-8 TSSOP-8	185 140	°C/W °C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	TSSOP-8	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	DFN8 DFN8	129 84	°C/W °C/W
T <sub>sol</sub>	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 5. 10EL SERIES PECL DC CHARACTERISTICS  $V_{CC}$ = 5.0 V;  $V_{EE}$ = 0.0 V (Note 2)

			-40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		14	17		14	17		14	17	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 3)	3920	4010	4110	4020	4105	4190	4090	4185	4280	mV
V <sub>OL</sub>	Output LOW Voltage (Note 3)	3050	3200	3350	3050	3210	3370	3050	3227	3405	mV
V <sub>IH</sub>	Input HIGH Voltage	3770		4110	3870		4190	3940		4280	mV
V <sub>IL</sub>	Input LOW Voltage	3050		3500	3050		3520	3050		3555	mV
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5			0.5			0.3			μА

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 2. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.06 V / -0.5 V.
- 3. Outputs are terminated through a 50 ohm resistor to  $V_{CC}$ -2 volts.

Table 6. 10EL SERIES NECL DC CHARACTERISTICS V<sub>CC</sub>= 0.0 V; V<sub>EE</sub>= -5.0 V (Note 4)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		14	17		14	17		14	17	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 5)	-1080	-990	-890	-980	-895	-810	-910	-815	-720	mV
V <sub>OL</sub>	Output LOW Voltage (Note 5)	-1950	-1800	-1650	-1950	-1790	-1630	-1950	-1773	-1595	mV
V <sub>IH</sub>	Input HIGH Voltage	-1230		-890	-1130		-810	-1060		-720	mV
V <sub>IL</sub>	Input LOW Voltage	-1950		-1500	-1950		-1480	-1950		-1445	mV
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5			0.5			0.3			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 4. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.06 V / -0.5 V.
- 5. Outputs are terminated through a 50 ohm resistor to V<sub>CC</sub>-2 volts.

Table 7. 100EL SERIES PECL DC CHARACTERISTICS  $V_{CC}$ = 5.0 V;  $V_{EE}$ = 0.0 V (Note 6)

			-40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		14	17		14	17		16	19	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 7)	3915	3995	4120	3975	4045	4120	3975	4050	4120	mV
V <sub>OL</sub>	Output LOW Voltage (Note 7)	3170	3305	3445	3190	3295	3380	3190	3295	3380	mV
V <sub>IH</sub>	Input HIGH Voltage	3835		4120	3835		4120	3835		4120	mV
V <sub>IL</sub>	Input LOW Voltage	3190		3525	3190		3525	3190		3525	mV
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 6. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.8 V / -0.5 V.
- 7. Outputs are terminated through a 50 ohm resistor to V<sub>CC</sub>-2 volts.

Table 8. 100EL SERIES NECL DC CHARACTERISTICS V<sub>CC</sub>= 0.0 V; V<sub>EE</sub>= -5.0 V (Note 8)

			-40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		14	17		14	17		16	19	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 9)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V <sub>OL</sub>	Output LOW Voltage (Note 9)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V <sub>IH</sub>	Input HIGH Voltage	-1165		-880	-1165		-880	-1165		-880	mV
V <sub>IL</sub>	Input LOW Voltage	-1810		-1475	-1810		-1475	-1810		-1475	mV
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 8. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.8 V / -0.5 V.
- 9. Outputs are terminated through a 50 ohm resistor to  $V_{CC}$ -2 volts.

Table 9. AC CHARACTERISTICS V<sub>CC</sub>= 5.0 V; V<sub>EE</sub>= 0.0 V or V<sub>CC</sub>= 0.0 V; V<sub>EE</sub>= -5.0 V (Note 10)

			-40°C 25°C		85°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency					1.5					GHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay to Output  D to Q  SEL to Q	60 90	220 250	380 410	120 150	230 260	340 370	140 170	250 280	360 390	ps
t <sub>JITTER</sub>	Random Clock Jitter (RMS)					0.9					ps
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times Q (20% – 80%)	100	225	350	100	225	350	100	225	350	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

10.10 Series:  $V_{EE}$  can vary +0.06 V / -0.5 V. 100 Series:  $V_{EE}$  can vary +0.8 V / -0.5 V.

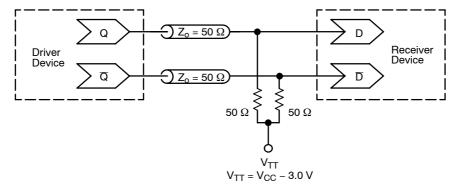


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>					
MC10EL58D	SOIC-8	98 Units / Rail					
MC10EL58DG	SOIC-8 (Pb-Free)	98 Units / Rail					
MC10EL58DR2	SOIC-8	2500 / Tape & Reel					
MC10EL58DR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel					
MC10EL58DT	TSSOP-8	100 Units / Rail					
MC10EL58DTG	TSSOP-8 (Pb-Free)	100 Units / Rail					
MC10EL58DTR2	TSSOP-8	2500 / Tape & Reel					
MC10EL58DTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel					
MC10EL58MNR4	DFN8	1000 / Tape & Reel					
MC10EL58MNR4G	DFN8 (Pb-Free)	1000 / Tape & Reel					
MC100EL58D	SOIC-8	98 Units / Rail					
MC100EL58DG	SOIC-8 (Pb-Free)	98 Units / Rail					
MC100EL58DR2	SOIC-8	2500 / Tape & Reel					
MC100EL58DR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel					
MC100EL58DT	TSSOP-8	100 Units / Rail					
MC100EL58DTG	TSSOP-8 (Pb-Free)	100 Units / Rail					
MC100EL58DTR2	TSSOP-8	2500 / Tape & Reel					
MC100EL58DTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel					
MC100EL58MNR4	DFN8	1000 / Tape & Reel					
MC100EL58MNR4G	DFN8 (Pb-Free)	1000 / Tape & Reel					

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **Resource Reference of Application Notes**

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPICE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

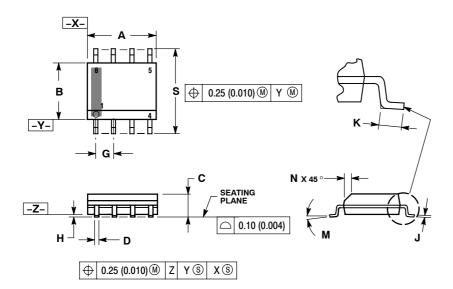
AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

#### PACKAGE DIMENSIONS

### SOIC-8 NB CASE 751-07 **ISSUE AH**



#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

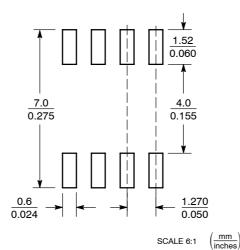
  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.

  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
  PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL
  IN EXCESS OF THE D DIMENSION AT
  MAXIMUM MATERIAL CONDITION.
  6. 751–01 THRU 751–06 ARE OBSOLETE. NEW
  STANDARD IS 751, 07
- STANDARD IS 751-07.

	MILLIN	IETERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		
Α	4.80	5.00	0.189	0.197		
В	3.80	4.00	0.150	0.157		
С	1.35	1.75	0.053	0.069		
D	0.33	0.51	0.013	0.020		
G	1.27	BSC	0.050 BSC			
Н	0.10	0.25	0.004	0.010		
J	0.19	0.25	0.007	0.010		
K	0.40	1.27	0.016	0.050		
M	0 °	8 °	0 °	8 °		
N	0.25	0.50	0.010	0.020		
S	5.80	6.20	0.228	0.244		

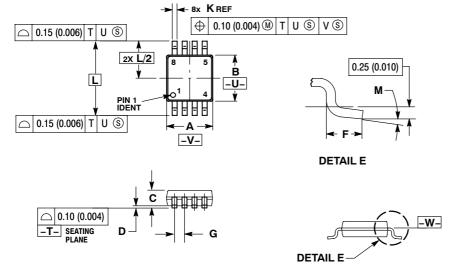
#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **PACKAGE DIMENSIONS**

#### TSSOP-8 **DT SUFFIX** PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
- 2. CONTINGUING DIMENSION, MILLIDIETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.
  PROTRUSIONS OR GATE BURRS. MOLD FLASH
  OR GATE BURRS SHALL NOT EXCEED 0.15
- (0.006) PER SIDE.

  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  5. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
  6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	2.90	3.10	0.114	0.122			
В	2.90	3.10	0.114	0.122			
C	0.80	1.10	0.031	0.043			
D	0.05	0.05 0.15		0.006			
F	0.40	0.70	0.016	0.028			
G	0.65	BSC	0.026	BSC			
K	0.25	0.40	0.010	0.016			
L	4.90	BSC	0.193	BSC			
M	0°	6 °	0°	6°			

#### PACKAGE DIMENSIONS

#### DFN8 CASE 506AA-01 ISSUE D

NOTES:

DIM

Α

Δ3

D

D2

E2

 DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994 .
CONTROLLING DIMENSION: MILLIMETERS.

DIMENSION b APPLIES TO PLATED
TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
COPLANARITY APPLIES TO THE EXPOSED

PAD AS WELL AS THE TERMINALS. MILLIMETERS

1.00

MIN MAX

0.00 0.05

0.20 REF 0.20 0.30

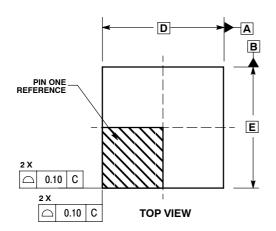
2.00 BSC

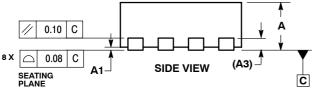
1.10 1.30 2.00 BSC 0.70 0.90

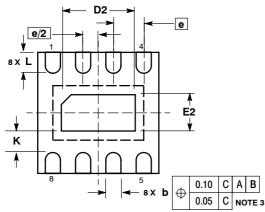
0.50 BSC

0.20 0.25

0.80







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